

Operator's Manual

optris[®] Xi

80/400



Spot finder IR camera

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Table of contents

Ta	able of	contents	3	
1	General Notes			
	1.1	Intended use	8	
	1.2	Warranty	9	
	1.3	Scope of delivery	10	
	1.4	Maintenance	10	
	1.4.	1 Cleaning	10	
	1.5	Model overview	11	
2	Тес	hnical Data	12	
	2.1	General specifications	12	
	2.2	Electrical specifications	16	

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1	2.3	Mea	surement specifications	.17
	2.4	Opti	cal specifications	.18
3	Мес	hani	cal Installation	.24
;	3.1	Dim	ensions	.24
	3.2	Acce	essories	.28
	3.2.2	1	Air purge laminar	.28
	3.2.2	2	Water cooling	.32
	3.2.3	3	Shutter	.35
	3.2.4	4	Combination of air purge, water cooling and shutter	.39
	3.2.5	5	Outdoor protective housing	.44
4	Elec	trica	Il Installation	.45
4	4.1	Proc	cess interface	.46
	4.1.1	1	Process interface Xi 80	.46

Table of contents

	4.1.2	2	Process interface Xi 400	49
	4.1.3	3	PIN allocation Xi 80	52
	4.1.4	4	PIN allocation Xi 400	53
	4.1.	5	Industrial Process Interface for Xi 80 (optional)	55
	4.1.	6	Industrial Process Interface for Xi 400 (optional)	60
	4.2	Exa	mple for a Fail-Safe monitoring of the Xi with a PLC	64
	4.3	USE	3 cable extension for Xi 400	66
5	Fun	ctior	1S	67
	5.1	Auto	onomous operation Xi 80	67
	5.1.	1	Hot- / Coldspot function in autonomous operation	71
	5.2	Ethe	ernet Xi 80	72
	5.2.	1	Ethernet setup (Point-to-Point-Connection)	73
	5.3	Use	of Shutter	78

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	5.3	3.1 Settings in PIX Connect Software	80
6	IRn	mobile App	81
7	Software PIX Connect		
-	7.1	Installation and initial start-up	84
-	7.2	Software window	86
-	7.3	Basis features of the software PIX Connect	88
8	Bas	asics of Infrared Thermometry	91
9 Emissivity			
9	Em	nissivity	96
-	Em 9.1	nissivity Definition	
ļ			96
	9.1	Definition	96
9	9.1 9.2 9.3	Definition Determination of unknown emissivity	96 98 100

Table of contents

Appendix C – Quick start for serial communication	104
Appendix D – Interprocess Communication (IPC)	106
Appendix E – PIX Connect Resource Translator	107
Appendix F – Wiring diagrams PIF for Xi 400	108
Appendix G – Declaration of Conformity	112

1 General Notes

1.1 Intended use

Thank you for choosing the **optris® Xi** spot finder infrared camera.

The optris Xi calculates the surface temperature based on the emitted infrared energy of objects [▶8 Basics of Infrared Thermometry]. The two-dimensional detector (FPA - focal plane array) allows a measurement of an area and will be shown as thermal image using standardized palettes. The radiometric processing of the picture data enables the user to do a comfortable detailed analysis with the software PIX Connect.

The Xi is a precise instrument and contains an extremely sensitive infrared detector and a highquality lens.



The alignment of the camera to **intensive energy sources** (e.g. devices which emit laser radiation or reflections of such equipment) can cause an **irreparable defect of the infrared detector**. This is also valid if the camera is switched off.

Such kinds of damages are excluded from warranty.



Read the manual carefully before the initial start-up. The producer reserves the right to change the herein described specifications in case of technical advance of the product.

General Notes

• Avoid abrupt changes of the ambient temperature.



- Avoid static electricity, arc welders, and induction heaters. Keep away from very strong EMF (electromagnetic fields).
- In case of problems or questions which may arise when you use the infrared camera, please contact our service department.



► All accessories can be ordered according to the referred part numbers in brackets [].

1.2 Warranty

Each single product passes through a quality process. Nevertheless, if failures occur contact the customer service at once. The warranty period covers 24 months starting on the delivery date. After the warranty is expired the manufacturer guarantees additional 6 months warranty for all repaired or substituted product components. Warranty does not apply to damages, which result from misuse or neglect. The warranty also expires if you open the product. The manufacturer is not liable for consequential damage or in case of a non-intended use of the product.

If a failure occurs during the warranty period the product will be replaced, calibrated or repaired without further charges. The freight costs will be paid by the sender. The manufacturer reserves the right to exchange components of the product instead of repairing it. If the failure results from misuse or neglect the user has to pay for the repair. In that case you may ask for a cost estimate beforehand.

1.3 Scope of delivery

- Xi 80 or Xi 400
- USB cable: 1 m (standard scope of supply, no IP67 protection class)
 - 1 m, 3 m, 5 m, 10 m, 20 m * (optional, for industrial applications, with IP67)
- Mounting nut and mounting bracket (adjustable in one axis, tripod thread)
- Process interface cable incl. terminal block (1 m)
- Software package PIX Connect
- Quick start guide

* 20 m version not available for Xi 80

1.4 Maintenance

Never use cleaning compounds which contain solvents (neither for the lens nor for the housing).

1.4.1 Cleaning

Blow off loose particles using clean compressed air. The lens surface can be cleaned with a soft, humid tissue (moistened with water) or a lens cleaner (e.g. Purosol or B+W Lens Cleaner).

1.5 Model overview

The cameras of the PI-series are available in the following basic versions:

Modell	Model code	Temperature range	Spectral range	Frame rate	Typical applications
Xi 80	IR	-20 to 900 °C	8 - 14 µm	50 Hz	Surface measurements in industrial application, autonomous operation with automatic spot finder
Xi 400	IR	-20 to 900 °C	8 - 14 µm	80 Hz/ 27 Hz	Real-time thermographic images in high speed; Detection of smallest temperature differences

Table 1: Model overview

2.1 General specifications

Environmental rating:	IP67 (NEMA-4)
Ambient temperature:	050 °C
Storage temperature:	-4070 °C
Relative humidity:	1095 %, non-condensing
Material (housing):	Stainless steel
Dimensions:	Xi 80: 36 x 90 mm / M30 Xi 400: 36 x 100 mm / M30
Weight (without mounting bracket):	Xi 80: 201-210 g (depending on optics) Xi 400: 216-220 g (depending on optics)
Cable length:	USB: 1 m (standard), 3 m, 5 m, 10 m, 20 m (20 m version not available for Xi 80) Ethernet / RS485 (Xi 80): 100 m
Vibration ¹⁾ :	IEC 60068-2-6 (sinus shaped) IEC 60068-2-64 (broadband noise)
Shock ¹⁾ :	IEC 60068-2-27 (25 G and 50 G)

¹⁾ Used standards for vibration and shock:

DIN EN 60068-1:1995-03 IEC 60068-1:1988 + Corr. 1988 + A1: 1992 "Umweltprüfungen - Teil 1: Allgemeines und Leitfaden" IEC 60068-2-6:2007 DIN EN 60068-2-6: VDE 0468-2-6:2008-10 "Umgebungseinflüsse - Teil 2-6: Prüfverfahren - Prüfung Fc: Schwingen (sinusförmig)" IEC 60068-2-27:2008 DIN EN 60068-2-27; VDE 0468-2-27:2010-02 "Umgebungseinflüsse - Teil 2-27: Prüfverfahren - Prüfung Ea und Leitfaden: Schocken" IEC 60068-2-47.2005 DIN EN 60068-2-47:2006-03 "Umgebungseinflüsse - Teil 2-47: Prüfverfahren - Befestigung von Prüflingen für Schwing-, Stoß- und ähnliche dynamische Prüfungen" IEC 60068-2-64:2008 DIN EN 60068-2-64; VDE 0468-2-64:2009-04 "Umgebungseinflüsse - Teil 2-64: Prüfverfahren - Prüfung Fh: Schwingen, Breitbandrauschen (digital geregelt) und Leitfaden"

Figure 1: Used standards

Stress program (camera in operation):

Shock, half sinus 25 G – testin	hock, half sinus 25 G – testing Ea 25 G (acc. IEC 60068-2-27)				
Acceleration	245 m/s ²	(25 G)			
Pulse duration	11 ms				
Number of directions	6	(3 axes with 2 directions each)			
Duration	600 Shocks	(100 Shocks each direction)			

Shock, half sinus 50 G – testing Ea 50 G (acc. IEC 60068-2-27)				
Acceleration	490 m/s ²	(50 G)		
Pulse duration	11 ms			
Number of directions	6	(3 axes with two directions each)		
Duration	18 Shocks	(3 Shocks each direction)		
Vibration, sinus shaped – test	ing Fc (acc. IEC60068-2-6)		
Frequency range	10 - 500 Hz			
Acceleration	29.42 m/s ²	(3 G)		
Frequency change	1 Octave/ min			
Number of axes	3			
Duration	1:30 h	(3 x 0.30 h)		
Vibration, broadband noise – testing Fh (acc. IEC60068-2-64)				
Frequency range	10 - 2000 Hz			

Acceleration	39.3 m/s ²	(4.01 G _{RMS}))	
Frequency spectrum	10 - 106 Hz	0.9610 (m/s²)²/Hz	(0.010 G ² /Hz)
	106 - 150 Hz	+6 dB/ Octave	
	150 - 500 Hz	1.9230 (m/s²)²/Hz	(0.020 G ² /Hz)
	500 - 2000 Hz	-6 dB/ Octave	
	2000 Hz	0.1245 (m/s²)²/Hz	(0.00126 G ² /Hz)
Number of axes	3		
Duration	3 h	(3 x 1 h)	

2.2 Electrical specifications

Power Supply:	Xi 80: USB/ PoE/ 5-30 VDC Xi 400: USB
Current draw:	Max 500 mA
AO: Output Standard/Internal Process Interface (PIF out)	0 - 10 V (Xi 400), 0/4 – 20 mA (Xi 80) (Main measure area, measure area, internal temperature, flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication) [▶ Appendix F – Wiring diagrams PIF]
AI: Input Standard/Internal Process Interface (PIF in)	0 - 10 V (Emissivity, ambient temperature, reference temperature, uncommitted value, flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range) [▶ Appendix F – Wiring diagrams PIF]
DI: Digital Input Standard Process Interface (Xi 400)	Flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak- /valley-hold, switch temperature range [▶ Appendix F – Wiring diagrams PIF]
Digital interface:	Xi 80: USB 2.0/ Ethernet/ RS485 Xi 400: USB 2.0/ optional USB to GigE (PoE) conversion

2.3 Measurement specifications

	<u>Xi 80</u>	<u>Xi 400</u>	
Temperature ranges	-20100 °C; 0250 °C; (20) 150900 °C ¹⁾		
Spectral range	8 - 14 µm		
Detector	UFPA, 80 x 80 pixel @ 50 Hz	UFPA, 382 x 288 pixel @ 80 Hz/ 27 Hz	
Lenses (FOV)	12° x 12° (F=1,0); 30° x 30° (F=0,9); 55° x 55° (F=0,9); 80° x 80° (F=0,9)	18° x 14° (F=1,1); 29° x 22° (F=0,9); 53° x 38° (F=0,9); 80° x 54° (F=0,9)	
Microscope lens (FOV)	-	18° x 14° (F=1,1, minimum spot size: 81 μm @ 90 mm, working distance: 90-110 mm)	
Optical resolution	190:1 (12° optic)	390:1 (18° optic)	
System accuracy ²⁾	±2 °C or ±2 %		
Thermal sensitivity (NETD):	100 mK	80 mK	
Warm-up time	10 min		
Emissivity	0.1001.100		
Software	PIX Connect		

 $^{1)}$ Accuracy statement effective from 150 $^{\circ}\mathrm{C}$

²⁾ At ambient temperature 23±5 °C; whichever is greater

2.4 Optical specifications



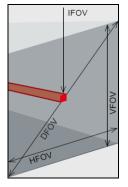
Make sure that the focus of thermal channel is adjusted correctly. The cameras have a **motorized focus**, which can be adjusted in the PIX Connect software (Menu **View/ Windows/Distance** or over the icon \square). An adjustment to the left leads to the focus setting "near" and an adjustment to the right to the focus setting "infinite".



Figure 2: Motorized focus settings in PIX Connect

The variety of different lenses offers the possibility to precisely measure objects in different distances. We offer lenses for close, standard distances and large distances. Please note that the Xi has a fixed optic. A change of optics is not possible. Different parameters are important if using infrared cameras. They display the connection between the distance of the measured object and the size of the pixel (**Table 2**).

- **HFOV**: Horizontal enlargement of the total measuring at object level
- **VFOV**: Vertical enlargement of the total measuring at object level
- **IFOV**: Size at the single pixel at object level
- **DFOV**: Diagonal dimension of the total measuring field at object level
- MFOV: Recommended, smallest measured object size of 3 x 3 pixel (Xi 400) and 2 x 2 pixel (Xi 80)



Geometric resolution for ideal temperature measurement

When designing optics for measuring IR cameras, special attention must be paid to the quality of detail contrast with which an object can be represented in the image. This is described by the modulation transfer function (MTF). Since in contrast to visual cameras, with IR cameras the thermal contrast is of more interest, this is used together with the slit response function (SRF). The result is determined by the number of pixels an object needs to fill to allow its temperature to be measured exactly. In high-performance infrared optical systems as used by Optris, this is **3×3 pixels** or **2×2 pixels**, with lower quality optical systems, in some circumstances as many as 10×10 pixels may be required, to receive **90 %** of the energy. A high-performance

camera lens also allows a larger measuring distance with the same number of pixels of the detector, or the precise temperature measurement of smaller structures and objects. The **3x3 pixel** (2x2 pixels) geometry is described as **MFOV (measurement field of view)** - one single pixel on the object surface is described as **IFOV (instantaneous field of view)**. The MFOV is comparable with the measuring spot definition with infrared thermometers.

The following tables with examples showing what spot sizes and pixel sizes will be reached in which distance. For individual configuration there are different lenses available. Wide angle lenses have a radial distortion due to their large opening angle; the software PIX Connect has an algorithm which corrects this distortion. As an alternative to the tables below, the <u>optics</u> <u>calculator</u> can also be used on the optris website or via the <u>optris calculator app</u>. The app can be downloaded for free from the Google Play Store (see QR code).









Table 2:

Xi 80	Focal length [mm]	Minimum measurement distance*	Angel	Distance to measurement object [m]												
80 x 80 px					0.05	0.1	0.2	0.3	0.5	1	2	4	6	10	30	100
F05 Standard lens	5	0,2 m	30°	HFOV [m]	0.028	0.056	0.111	0.167	0.279	0.557	1.115	2.230	3.346	5.6	16.7	55.8
			30°	VFOV [m]	0.028	0.056	0.111	0.167	0.279	0.557	1.115	2.230	3.346	5.6	16.7	55.8
			43°	DFOV [m]	0.039	0.079	0.158	0.24	0.39	0.79	1.58	3.15	4.7	7.9	23.7	78.9
			6,67 mrad	IFOV [mm]	0.33	0.67	1.33	2.0	3.33	6.67	13.33	26.67	40.00	66.67	200.00	666.67
F13 Telephoto lens	13	0,3 m	12°	HFOV [m]		0.022	0.043	0.065	0.11	0.21	0.43	0.85	1.28	2.1	6.4	21.3
			12°	VFOV [m]		0.022	0.043	0.065	0.11	0.21	0.43	0.85	1.28	2.1	6.4	21.3
			17°	DFOV [m]		0.031	0.061	0.092	0.15	0.30	0.60	1.20	1.81	3.0	9.0	30.1
			2,66 mrad	IFOV [mm]		0.3	0.5	0.8	1.3	2.7	5.3	10.6	15.9	26.6	79.7	265.6
F03 Wide angle lens	3	0,2 m	55°	HFOV [m]	0.057	0.110	0.218	0.325	0.539	1.07	2.14	4.27	6.41	10.7	32.0	106.7
			55°	VFOV [m]	0.057	0.110	0.218	0.325	0.539	1.07	2.14	4.27	6.41	10.7	32.0	106.7
			79°	DFOV [m]	0.080	0.156	0.308	0.459	0.762	1.52	3.02	6.04	9.06	15.1	45.3	150.9
			11,15 mrad	IFOV [mm]	0.6	1.2	2.3	3.4	5.6	11.2	22.4	44.6	66.9	111.5	334.5	1114.8
F02 Super wide angle lens	2	0,2 m	80°	HFOV [m]	0.090	0.174	0.343	0.509	0.884	1.682	3.357	6.708	10.058	16.8	50.3	167.5
			80°	VFOV [m]	0.090	0.174	0.343	0.509	0.88	1.682	3.357	6.708	10.058	16.8	50.3	167.5
			113°	DFOV [m]	0.127	0.246	0.483	0.72	1.19	2.38	4.75	9.49	14.2	23.7	71.1	236.9
			15,45 mrad	IFOV [mm]	80.0	1.6	3.2	4.7	7.8	15.5	31.0	61.9	92.8	154.6	463.7	1545.5

* Note: The accuracy of measurement can be outside of the specifications for distances below the defined minimum distance.

Xi 400 55		n ment		Distance to measurement object [m]												
382 x 288 px	Focal length [mm]	Min imum measurement distance*	Angle		0.05	0.1	0.2	0.3	0.5	1	2	4	6	10	30	100
F12 Standard lens	13	0.35 m	29°	HFOV [m]		0.055	0.111	0.16	0.27	0.52	1.04	2.1	3.1	5.2	15.5	51.7
			22°	VFOV [m]		0.042	0.081	0.12	0.20	0.39	0.78	1.6	2.3	3.9	11.7	38.9
			37°	DFOV [m]		0.069	0.137	0.20	0.33	0.66	1.30	2.6	3.9	6.5	19.4	64.7
			1.3 mrad	IFOV [mm]		0.1	0.3	0.4	0.7	1.3	2.7	5.4	8.0	13.4	40.2	133.9
F20 Telephoto lens	20	0.35 m	18°	HFOV [m]			0.067	0.099	0.16	0.32	0.65	1.29	1.9	3.2	9.7	32.2
			14°	VFOV [m]			0.051	0.076	0.12	0.25	0.49	0.98	1.5	2.5	7.4	24.6
			23°	DFOV [m]			0.084	0.125	0.21	0.41	0.81	1.62	2.4	4.1	12.2	40.5
			0.9 mrad	IFOV [mm]			0.2	0.3	0.4	0.9	1.7	3.4	5.1	8.5	25.6	85.4
F08 Wide angle lens	8	0.25 m	53°	HFOV [m]		0.105	0.20	0.30	0.50	1.00	2.00	4.00	6.0	10.0	29.9	99.7
			38°	VFOV [m]		0.073	0.14	0.21	0.35	0.70	1.4	2.8	4.1	6.9	20.7	68.9
			66°	DFOV [m]		0.128	0.25	0.37	0.62	1.22	2.4	4.9	7.30	12.1	36.4	121.2
			2.2 mrad	IFOV [mm]		0.22	0.4	0.7	1.1	2.2	4.4	8.8	13.2	22.0	65.9	219.6
F06 Super wide angle lens	6	0.2 m	80°	HFOV [m]	0.085	0.16	0.32	0.48	0.82	1.7	3.4	6.7	10.1	16.8	50.4	167.8
			54°	VFOV [m]	0.055	0.10	0.20	0.30	0.51	1.0	2.0	4.1	6.1	10.2	30.6	101.9
			96°	DFOV [m]	0.101	0.19	0.38	0.57	0.97	1.9	3.9	7.9	11.8	19.7	58.9	196.4
			3.0 mrad	IFOV [mm]	0.2	0.3	0.6	0.9	1.5	3.0	6.0	12.0	18.1	30.1	90.3	301.2

* Note: The accuracy of measurement can be outside of the specifications for distances below the defined minimum distance.

Microscope optics	÷	ent		Distance to measurement object [m]					
Xi 400 382 x 288 px	Focal length [mm]	Minimum measurement distance*	Angle		0.09	0.1	0.11		
F20 CF Microscope optics	20	0.09 m	18° 14°	HFOV [m] VFOV [m]	0.031	0.034	0.037		
			23°	DFOV [m]	0.024	0.020	0.020		
			0.9 mrad	IFOV [mm]	0.08	0.09	0.10		

* Note: The accuracy of measurement can be outside of the specifications for distances below the defined minimum distance.

3 Mechanical Installation

3.1 Dimensions

The Xi is equipped with a metric M30x1 thread and can be installed either directly via the sensor thread or with help of the supplied mounting nut (standard) and adjustable mounting bracket (standard) to a mounting device available.



Figure 3: Xi with mounting bracket

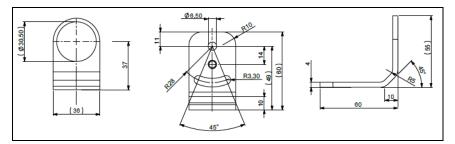


Figure 4: Mounting bracket, adjustable in one axis, with tripod thread [Order No. - ACXIFB] – standard scope of supply



For correct orientation, the USB port must be on the left side and the PIF port on the right side, see **Figure 5** or **Figure 6**.

Mechanical Installation

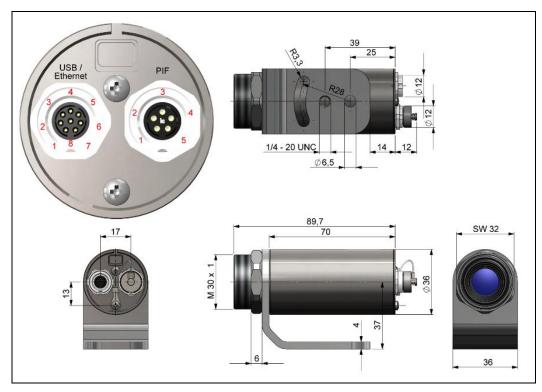


Figure 5: Xi 80, dimensions [mm]

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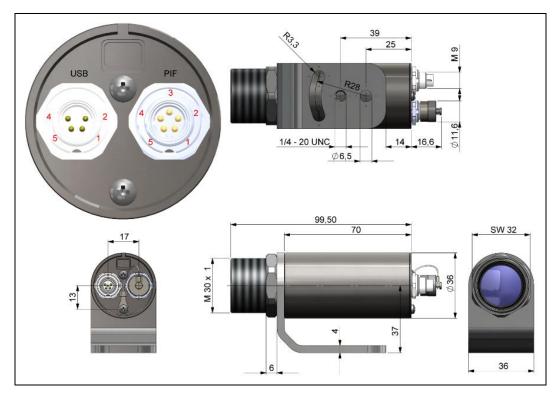


Figure 6 : Xi 400, dimensions [mm]

Mechanical Installation

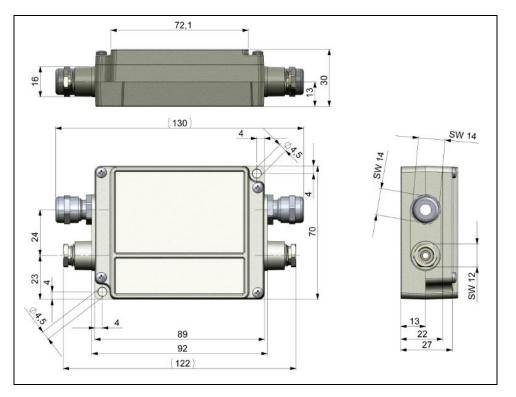


Figure 7: Industrial/stackable PIF (Process Interface) – electronic box, control box shutter, dimensions [mm]

3.2 Accessories

3.2.1 Air purge laminar

The lens must be kept clean at all times from dust, smoke, fumes and other contaminants in order to avoid reading errors. These effects can be reduced by using an air purge. (**Part-No.: ACXIAPL**)

- Make sure to use oil-free, technically clean air, only.
- The needed amount of air (approx. 2...10 l/min.) depends on the application and the installation conditions on-site.
- i
- The laminar air purge has a Si-protective window. Typical transmission value: 0.82 (deviations possible), replacement window available under the **Part-No.: ACXIAPLPWSI**
- The corresponding mounting bracket (Part-No.: ACXIAPLAB) is mandatory.
- Material: Anodized aluminum, weight: 218 g / 494 g with mounting bracket
- Ambient temperature: 0...80 °C (T_{Amb} camera: 0...50 °C)

Air flow

The air purge can be mounted in four different positions.

The direction of the airflow must always be clear.

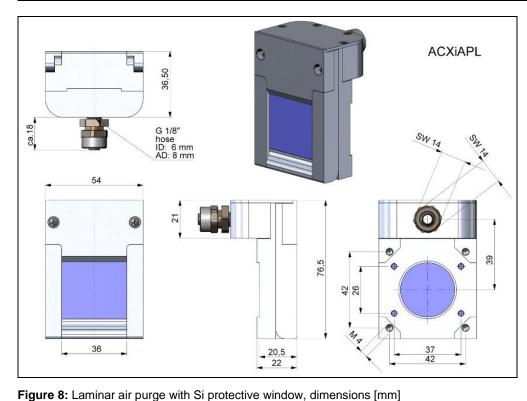








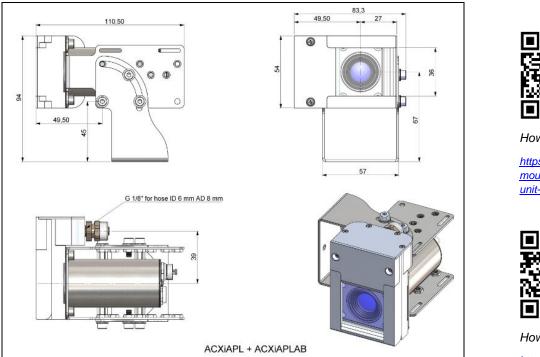
Mechanical Installation

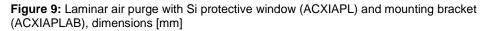




How-to Video Replacement of Siprotective window

https://www.optris.global/ replacement-of-the-siprotective-window-ofthe-laminar-air-purgeattachment







How-to video Xi 80

https://www.optris.global/ mounting-the-air-purgeunit-on-xi-80



How-to video Xi 400

https://www.optris.global/ mounting-the-air-purgeunit-on-xi-400

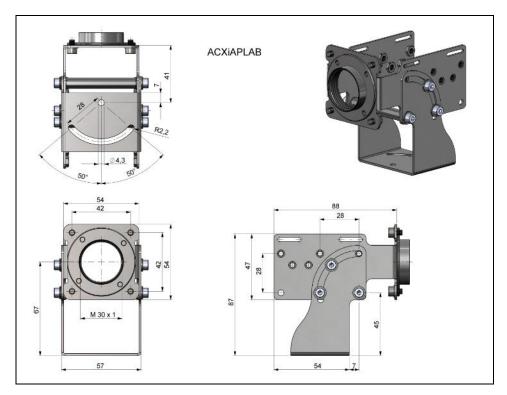


Figure 10: Mounting bracket (ACXIAPLAB), dimensions [mm], weight: 276 g

3.2.2 Water cooling

The IR camera is for application at ambient temperatures up to 50 °C. For applications at higher ambient temperatures we recommend the usage of the optional water cooled housing (operating temperature up to 250 °C) and the optional high temperature cable (operating temperature up to 250 °C).

- When using water cooling, a corresponding mounting kit (**Part-No.: ACXIxxxWAKx**) is required (WAK1: Usage without air purge, WAK2: Usage with air purge).
- Water flow rate: approx. 1-5 I/ min (Cooling water temperature should not exceed 30 °C)
- When using the water cooling the air purge (**Part-No.: ACXIAPL**) is recommended in order to avoid condensation
- Material: Stainless steel
- Weight: 1480 g

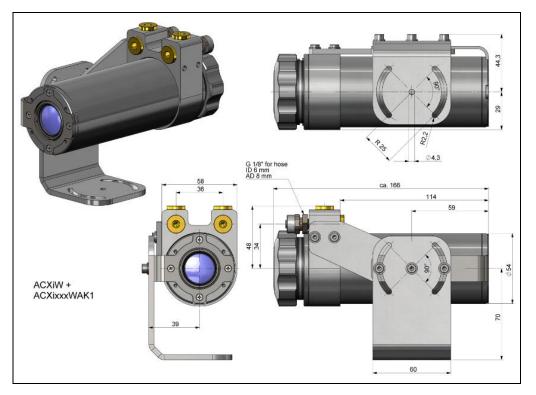


Figure 11: Water cooling (ACXIW) and mounting kit (ACXIxxxWAK1), dimensions [mm], weight: 1710 g

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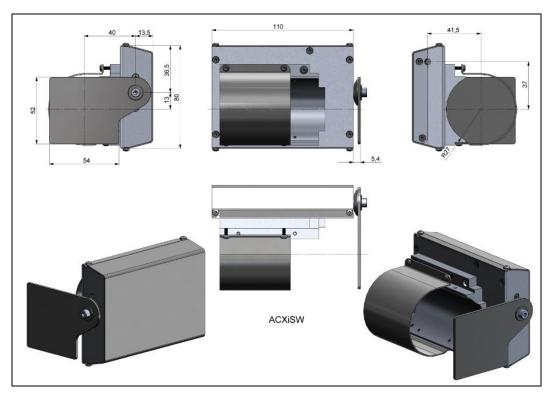


Figure 12: Shutter for water cooling (ACXISW), dimensions [mm], weight: 600 g

3.2.3 Shutter

To protect the optics of the camera, an optional shutter (closing mechanism) can be purchased. It is equipped with a servomotor that can open and close a mechanical lock as needed. The special feature of the shutter is not only the opening and closing, but also the complete seal in the closed state. This ensures that the shutter is completely closed and no dirt can get on the optics.

- The shutter has a 100 ms fast-closing mode.
- Complete seal when closed.
- Includes a control box for connections.
- Shutter can be used in combination with Process Interface (PIF).
- The corresponding mounting bracket (Part-No.: ACXIAPLAB) is mandatory.
- Material: Stainless steel
- Weight: 550 g / 826 g Shutter with mounting bracket
- When using more than one shutter and the opening / closing of the shutter should be simultaneously, the switch S4 on one control box must be set to mA and the others to mV (see **Figure 15**).
- Ambient temperature: 0...60 °C (T_{Amb} camera: 0...50 °C)

+optris

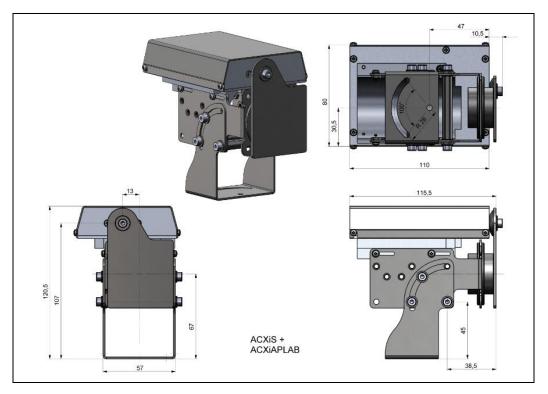


Figure 13: Shutter (ACXIS) with mounting bracket (ACXIAPLAB), dimensions [mm], weight: 826 g

Mechanical Installation

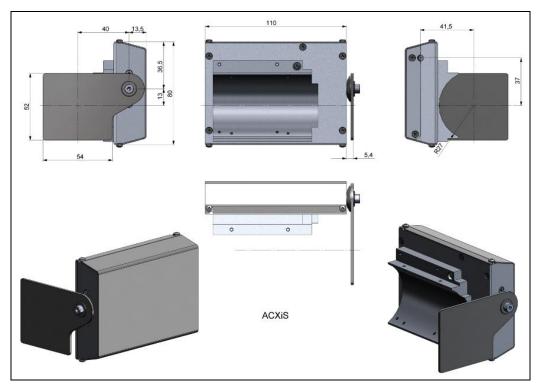


Figure 14: Shutter (ACXIS), dimensions [mm], weight: 550 g

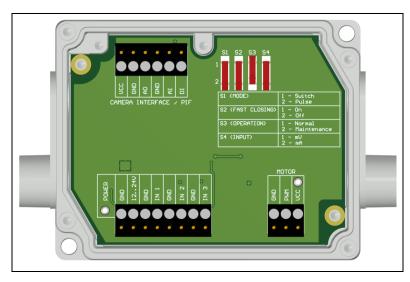


Figure 15: Control box of shutter, dimensions (see Figure 7)

Lower screw terminal: Connection for power supply, Inputs (Start/Stop signal) and Motor **Inputs** (Start/Stop signal, max. 24 V, input is active LOW (open input = HIGH)):

- **IN 1:** Trigger input for normal operation (S1)
- IN 2: Currently no usage
- IN 3: Trigger input for fast-closing mode (S2)

Power supply: 12-24 V

Upper terminal screw Connection for Process Interface (PIF)

Switch for different operation modes:

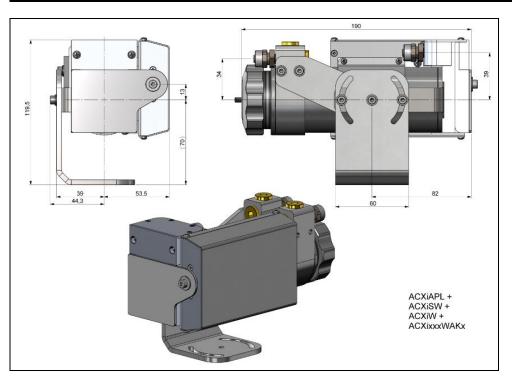
S1: Switching between switch operation and pulse operation
S2: Activation/deactivation of fast-closing mode
S3: Only for factory calibration (Switch must be at Normal)
S4: Switching between mV or mA input

Mechanical Installation

3.2.4 Combination of air purge, water cooling and shutter

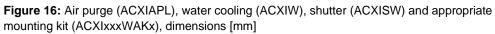
It is possible to combine all three components (air purge, water cooling and shutter) with each other. It should be noted that there are differences between the Xi 80 and Xi 400. Various mounting kits (ACXIxxxWAKx) are available in combination with water cooling. The mounting bracket (ACXIAPLAB) is always required for air purge and shutter. For water cooling (ACXIW), the mounting bracket is included and does not have to be ordered separately.

Part-No.: Combinations	ACXIAPL	ACXIAPLAB	ACXIS	ACXISW	ACXIW	ACX180WAK1	ACX180WAK2	ACX1400WAK1	ACX1400WAK2
Air purge	✓	✓							
Water cooling Xi 80					✓	\checkmark			
Water cooling Xi 400					✓			✓	
Shutter		\checkmark	✓						
Air purge and water cooling Xi 80	✓				✓		✓		
Air purge and water cooling Xi 400	✓				✓				✓
Air purge and shutter	✓	✓	✓						
Water cooling and shutter Xi 80				√	✓	\checkmark			
Water cooling and shutter Xi 400				✓	✓			✓	
Air purge, water cooling and shutter Xi 80	✓			✓	✓		\checkmark		
Air purge, water cooling and shutter Xi 400	✓			✓	✓				✓



Components:

- Air purge
- Water cooling
- Shutter
- Mounting kit



Mechanical Installation

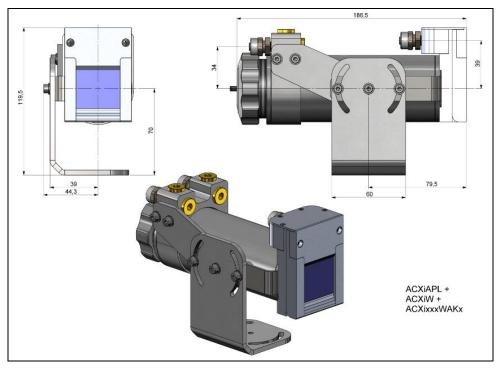


Figure 17: Air Purge (ACXIAPL), water Cooling (ACXIW) and appropriate mounting kit (ACXIxxxWAKx), dimensions [mm]

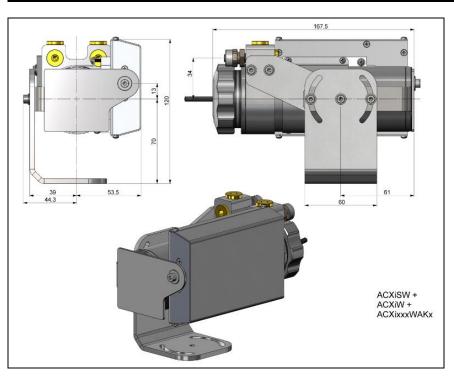
Components:

- Air purge
- Water cooling
- Mounting kit



How-to video

https://www.optris.global /assembly-of-xi-400-intothe-water-coolinghousing-with-the-use-ofthe-laminar-air-purge

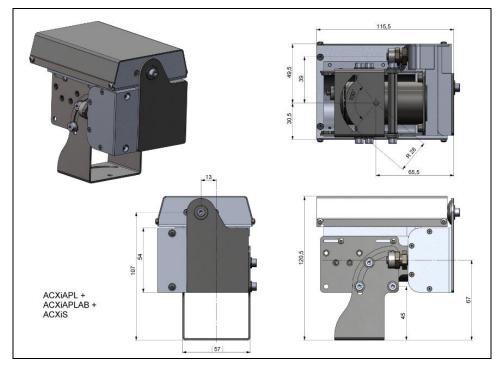


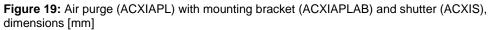
Components:

- Water cooling
- Shutter
- Mounting kit

Figure 18: Water Cooling (ACXIW), Shutter (ACXISW) and appropriate mounting kit (ACXIxxxWAKx), dimensions [mm]

Mechanical Installation





Components:

- Air purge
- Mounting bracket
- Shutter

3.2.5 Outdoor protective housing

- The infrared camera Xi can also be used for outdoor applications by using the outdoor protective housing (Part-No.: **ACXIOPH24**).
- In addition, the industrial or stackable PIF (Part-No.: ACCJAPIPIFMA (Xi 400) or ACOPHXIPIF (Xi 80)) can be installed as an accessory without housing and a USB Server (Part-No.: ACPIUSBSGB).
- For detailed information see installation manual.



Figure 20: Outdoor protective housing for Xi camera

4 Electrical Installation

At the back side of the Xi there are the two connector plugs (see Figure 21 and Figure 22).

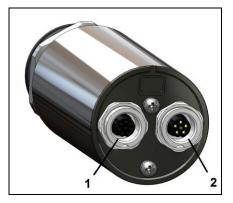


Figure 21: Backside of the Xi 80 with connectors

- 1 Plug for USB / Ethernet¹⁾ / PoE cable
- 2 Plug for in- and outputs or RS485

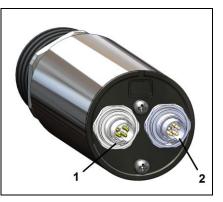


Figure 22: Backside of the Xi 400 with connectors

- 1 Plug for USB cable
- 2 Plug for PIF cable

¹⁾ When using the Ethernet connector, a 5...30 V DC power supply must be ensured via the terminal block

4.1 Process interface

4.1.1 Process interface Xi 80

The Xi 80 is equipped with an integrated process interface (cable with terminal block included in scope of supply), which can be programmed via the software as a direct analog input (AI), as a direct analog output (AO) in order to control the process or as an RS485 interface¹). The signal level is 0-10 V for AI and 0/4-20 mA for AO.



The process interface can be activated via the software choosing the following options:

Analog Input (AI):	Emissivity, ambient temperature, reference temperature, uncommitted value, flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range
Analog Output (AO):	Main measure area, measure area, internal temperature, flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication

¹⁾ Direct out- and inputs are not available while using the RS485 interface

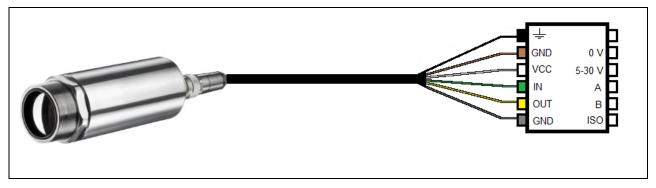


Figure 23: Configuration terminal block Xi 80

Ŧ		Shield	Black
GND	0 V	Ground	Brown
VCC	5-30 V	Power ¹⁾	White
IN	Α	Analog/Digital Input or RS485 (A)	Green
OUT	В	Analog Output or RS485 (B)	Yellow
GND	ISO	Isolated Ground for IN and OUT	Gray

¹⁾ Power supply only necessary when using the Ethernet connection (without PoE) or self-sufficient operation

The Xi 80 provides the following direct inputs and outputs:

<u>Name</u>	Description	<u>max range / status</u>
AI	Analog input	0-10 V ¹⁾
or DI	Digital input (active-low = 00,6 V)	24 V
AO	Analog output Alarm output	0/4-20 mA 0/4-20 mA

¹⁾ The AI is designed for max. 24 V, the voltage level above 10 V is not interpreted

In addition to the above direct in- and outputs, the Xi 80 has an RS485 interface. This interface can be used to control the external industrial PIF.

4.1.2 Process interface Xi 400



The process interface (electronics within cable as well as industrial interface) must be powered separately (5-24 VDC). Before switching on the power the PIF cable must be connected to the camera.

The Xi is equipped with a process interface (cable with integrated electronics and terminal block), which can be programmed via the software as an Analog Input (AI) and Digital Input (DI) in order to control the camera or as an Analog Output (AO) in order to control the process. The signal level is always 0-10 V (DI = 24 V).



The process interface can be activated via the software choosing the following options:

Analog Input (AI):	Emissivity, ambient temperature, reference temperature, uncommitted value, flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range
Analog Output (AO):	Main measure area, measure area, internal temperature, flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication
Digital Input (DI):	Flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range

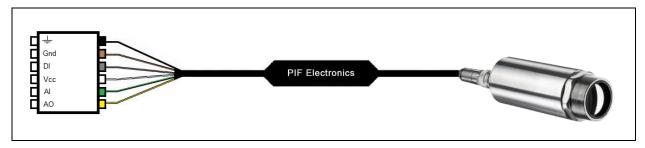


Figure 24: Configuration Standard Process Interface (PIF) Xi 400

50

÷	Shield	Black
Gnd	Ground	Brown
DI	Digital Input	Gray
Vcc	Power supply, 524 V DC	White
AI	Analog Input	Green
AO	Analog Output	Yellow

Electrical Installation

The standard process interface provides the following inputs and outputs:

<u>Name</u>	Description	max range ¹⁾ / status
AI	Analog input	0-10 V ²⁾
DI	Digital input (active-low = 00,6 V)	24 V
AO	Analog output Alarm output	0-10 V 0/ 10 V

¹⁾ Depending on supply voltage; for 0-10 V on the AO the PIF has to be powered with min. 12 V.
 ²⁾ The AI is designed for max. 24 V, the voltage level above 10 V is not interpreted

4.1.3 PIN allocation Xi 80

52



Figure 25: Rear side of Xi 80

USB	Ethernet	PIF
1 VCC		1 VCC
2 D +		2 RS485 or AO
3 D -		3 RS485 or AI
4	Tx +	4 GND
5	Тх -	5 GND-ISO
6	Rx +	
7	Rx -	
8 GND		

Electrical Installation

4.1.4 PIN allocation Xi 400



USB	PIF
1 VCC	1 INT
2 GND	2 SDA (I ² C)
4 D -	3 SCL (I ² C)
5 D +	4 DGND
	5 3,3 V (Out)

Figure 26: Rear side of Xi 400

54

If the process interface of the camera is directly connected to external hardware¹⁾ (without using the supplied PIF cable) an activation of the field "Support proprietary PIF cable" in the menu Tools/ Configuration/ Device (PIF) in the PIX Connect software is necessary.

Support proprietary PIF cable

Figure 27: Support proprietary PIF cable



Consider that the input of the PIF is not protected if there is a direct PIF connection! A voltage > 3 V on the INT pin will destroy the device!

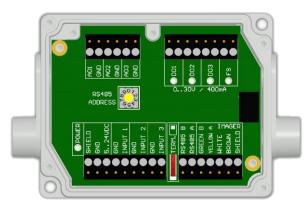
¹⁾ We recommend using only a switching contact between INT and DGND as external hardware (button, relay).

Electrical Installation

4.1.5 Industrial Process Interface for Xi 80 (optional)

For use in industrial environment the industrial process interface with 500 V AC_{RMS} isolation voltage between Xi and process is available (connection box with IP65, 5 m, 10 m or 20 m standard or high temperature cable for camera connection, terminal for process integration). [► Appendix F – Wiring diagrams PIF]

Pin assignment PIF cable (industrial process interface)



GREEN	RS485 B
YELLOW	RS485 A
WHITE	12 V
BROWN	GND
SHIELD	GND

Figure 28: Connections of the industrial Process Interface for Xi 80

The process interface can be activated via the software choosing the following options:

Analog Input (AI):	Emissivity, ambient temperature, reference temperature, uncommitted value, flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range
Analog Output (AO):	Main measure area, measure area, internal temperature, flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication
Digital Output (DO):	Flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication

56

Electrical Installation

<u>Name</u>	<u>Description</u>	max range ¹⁾ / status
INPUT 1 / 2 / 3	Analog or digital input	0-10 V ²⁾
AO1/2/3	Analog output 1, 2 and 3 Alarm output 1, 2 and 3	0-10 V 0/4-20 mA
DO1/2/3	Relay output 1, 2 and 3	open/ closed (red LED on) / 030 V, 400 mA
FS	Fail-safe relay	open/ closed (green LED on)/ 030 V, 400 mA

The industrial process interface provides the following in- and outputs:

¹⁾ depending on supply voltage; for 0-10 V on the AO the PIF has to be powered with min. 12 V. ²⁾ the AI is designed for max. 24 V, the voltage level above 10 V is not interpreted

 (\mathbf{i})

The industrial PIF has a maximum of 3 analog outputs. To use more outputs, you can cascade up to three PIFs, allowing you to use up to 9 analog or alarm outputs in total.

optris

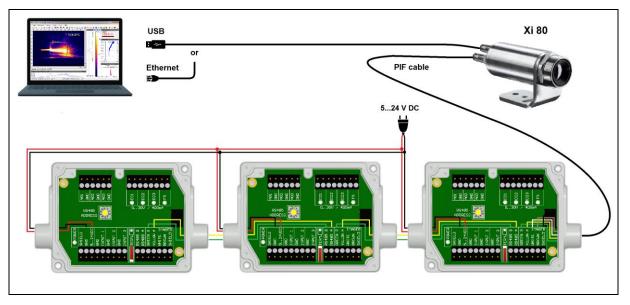


Figure 29: Connection of 3 industrial PIFs via RS485

 (\mathbf{i})

Each stackable industrial PIF must have its own **RS485 address**. The address must be set directly on the board and in the software. For the PIF which is the furthest away the **120R switch (TERM. – Termination)** has to be set.

58



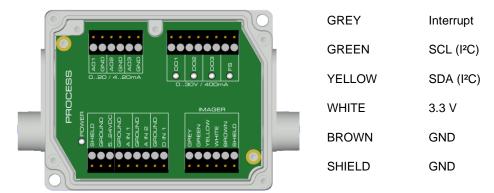
The RS485 interface is defined for a length of 500 m.

The process interface has an integrated fail-safe mode. This allows to control conditions like interruption of cables, shut-down of the software etc. and to give out these conditions as an alarm. The time constant of the fail-safe is 1.5 seconds.

Controlled conditions on camera and software	Standard Process interface ACXIIOCB1	Industrial Process interface ACXIPIFCBxx
Interruption USB cable to camera	\checkmark	
Interruption data cable camera - PIF	\checkmark	✓
Interruption power supply PIF	\checkmark	✓
Shut-down of PIX Connect software	\checkmark	-
Crash of PIX Connect software	-	-
Fail-Safe-Output	0 mA at analog output (AO)	open contact (fail-safe relay)/ green LED off

4.1.6 Industrial Process Interface for Xi 400 (optional)

For use in industrial environment the industrial process interface with 500 V AC_{RMS} isolation voltage between Xi and process is available (connection box with IP65, 5 m, 10 m or 20 m standard or high temperature cable for camera connection, terminal for process integration). [► Appendix F – Wiring diagrams PIF]



Pin assignment PIF cable (industrial process interface)

Figure 30: Connections of the industrial Process Interface for Xi 400

60

Electrical Installation

The process interface can be activated via the software choosing the following options:

Analog Input (AI):	Emissivity, ambient temperature, reference temperature, uncommitted value, flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range
Analog Output (AO):	Main measure area, measure area, internal temperature, flag status, recording status, line scan status, alarm, frame sync, fail-safe, external communication
Digital Input (DI):	Flag control, triggered recording, triggered snapshots, triggered line-scanner, triggered event grabber, reset peak-/valley-hold, switch temperature range

<u>Name</u>	Description	max range ¹⁾ / status
A IN 1 / 2	Analog input 1 and 2	0-10 V ²⁾
D IN 1	Digital input (active-low = 00,6 V)	24 V
AO1/2/3	Analog output 1, 2 and 3 Alarm output 1, 2 and 3	0/4-20 mA
DO1 / 2/ 3	Relay output 1, 2 and 3 3)	open/ closed (red LED on) / 030 V, 400 mA
FS	Fail-safe relay	open/ closed (green LED on)/ 030 V, 400 mA

The industrial process interface provides the following inputs and outputs:

¹⁾ depending on supply voltage; for 0-20 mA on the AO the PIF has to be powered with min. 5V < (1.5 + working resistance * 0.021) < 24 V; Example: $R_{Load} = 500 \text{ ohm} \rightarrow U_{min} = 1.5 + 500 * 0.021 = 12 \text{ V}, R_{Load} = 100 \text{ ohm} \rightarrow U_{min} = 1.5 + 100 * 0.021 = 3.6 \text{ V} \rightarrow min. 5 \text{ V}$ ²⁾ the AI is designed for max. 24 V, the voltage level above 10 V is not interpreted

³⁾ active if AO1, 2 or 3 is/ are programmed as alarm output



The alarm output can be configured as a threshold between 0-4 mA for no alarm and between 10-20 mA as alarm. For values outside the respective range, the relay does not switch on the DO.

Electrical Installation

The process interface has an integrated fail-safe mode. This allows to control conditions like interruption of cables, shut-down of the software etc. and to give out these conditions as an alarm. The time constant of the fail-safe is 1.5 seconds.

Controlled conditions on camera and software	Standard Process interface ACPIPIF	Industrial Process interface ACPIPIFMACBxx
Interruption USB cable to camera	V	\checkmark
Interruption data cable camera - PIF	\checkmark	\checkmark
Interruption power supply PIF	\checkmark	\checkmark
Shut-down of PIX Connect software	\checkmark	\checkmark
Crash of PIX Connect software	-	\checkmark
Fail-Safe-Output	0 V at analog output (AO)	open contact (fail-safe relay)/ green LED off

4.2 Example for a Fail-Safe monitoring of the Xi with a PLC

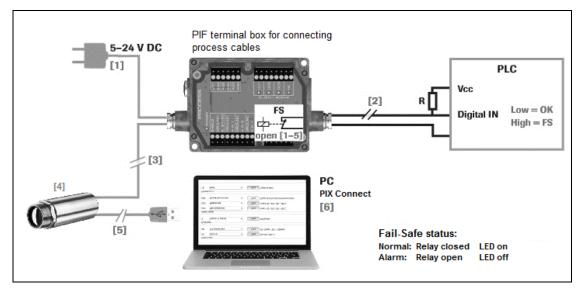


Figure 31: Fail-Safe monitoring states

Fail-Safe monitoring states

- [1] Breakdown of PIF power supply
- [2] Cable break of fail-safe cable
- [3] Interruption of cable Xi-PIF
- [4] Malfunction of Xi
- [5] Breakdown of Xi power supply/ Interruption of USB cable
- [6] Malfunction of PIX Connect software

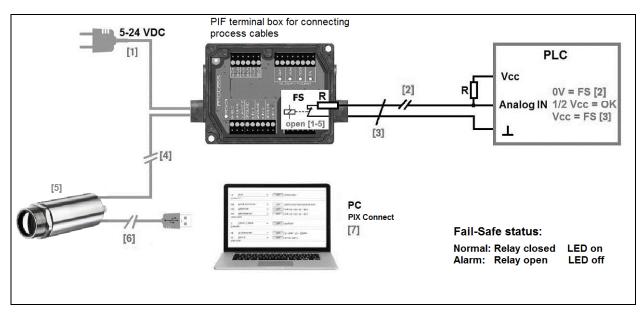


Figure 32: Fail-Safe monitoring states

Fail-Safe monitoring states

- [1] Breakdown of PIF power supply
- [2] Cable break of fail-safe cable
- [3] Short circuit of fail-safe cable
- [4] Interruption of cable Xi-PIF

- [5] Malfunction of Xi
- [6] Breakdown of Xi power supply/ Interruption of USB cable
- [7] Malfunction of PIX Connect software

4.3 USB cable extension for Xi 400

The maximum USB cable length is 20 m. For greater distances between Xi 400 and computer or for standalone solutions the optional USB Server Gigabit (**Part No.: ACPIUSBSGB**) is provided:

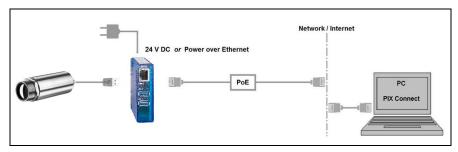


Figure 33: USB Server Gigabit

5 Functions

5.1 Autonomous operation Xi 80

A special feature of the Xi 80 is the autonomous operation. There is no need for a permanent connection to the PIX Connect software. Only a few settings must be set in advance in the software.

To do this, connect the PIF and USB cables to the device. Then connect the Xi to your PC and start the PIX Connect software (see **7 Software PIX Connect**).

Position and focus (see **2.4 Optical specifications**) the camera so that your object to be measured is perfectly visible in the image. First define the desired measurement area with the corresponding mode you want to output.

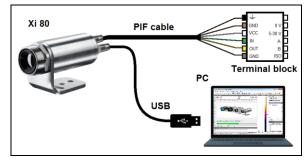


Figure 34: Connection Xi 80 to PC via USB

Now go to the configuration menu on **Device (PIF)**. There you first select the **PIF type** (in this case: **Internal PIF**). Then select under **Analog Outputs (AO)** the function that is to be output autonomously. Then press **Setup**, make your settings, and make sure that the checkbox is set to **using autonomously by device**. By pressing the **OK** button an @ sign can be found in the configuration menu Devices (PIF), which indicates the autonomous operation.

68

Configuration	
Snapshots / Copy to clipboard Trig. Recording / Snapshots Capture Screen Histogram Extended measuring Measuring colors IR Image arranging Alams Event grabber External Communication Extended Layout	Config PIF channel
General Measure areas Temp. profiles Temp./Time diagram Device Device (PIF) Recording Playing PIF type: Internal PIF	Process interface 20.0 [mÅ] High Migh Interface: AO1 19.0 19.0 19.0 19.0 19.0 10.0 </th
Analog Inputs (1)	Output mode: 020mA * 17.0 Measure area 16.0
Digital Inputs (1) + - Di: Not used Analog Outputs (1) + -	v using autonomously by device 14.0 13.0 Configuration range: 20.0°C100.0°C 20.0°C100.0°C
AO: Measure area V Setup @ Area 1: 4mA = 0°C / 20mA = 100°C	Low Range 11.0 Temperature 0.0 0.0 ** * * * * * * * * * * * * * *
DO: Not used	High Range 8,0 Temperature Current 100.0 m² °C = 20.00 m² 6,0 -
FS: Not used V Setup	Parameter 1.0 Gain: 160.00 μΔ/°C 4.0 Offset: 4.00 mA 3.0
Set number of ports like connected device	Links -20,0°C = 0,8mA 0mA = -25,0°C 1,0 0,0°C 2,0°A 20mA = 100,0°C -20,0 30,0 80,0 [°C]
Auto apply OK Apply Cancel	-20.0 30.0 80.0 Auto apply OK Apply Cancel

Figure 35: Configurations menu Device (PIF)

Figure 36: Setup

Functions

In general, these are all the settings that must be set in the PIX Connect software in order to operate the device autonomously. You can now close the software and then disconnect the USB cable. To start the device autonomously, a 5-30 V power supply must be connected to the terminal block. Now the used input/output must be connected. The resulting value can be displayed for example on a multimeter (see **Figure 37**). When using this variant, it can last for about half a minute until the device is ready for use in autonomous mode.

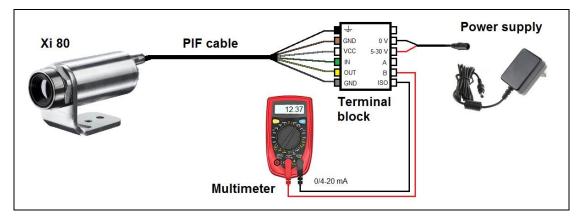


Figure 37: Electrical installation for autonomous operation Xi 80

 Autonomous operation also works via the industrial/stackable PIF of the Xi 80. The device is powered by the power supply of the PIF.



- Up to **9 measure areas** can be output <u>autonomously</u> (firmware 3013 or higher required). The use of three stackable PIFs is required. Three analog outputs are possible per stackable PIF. The response time is 20 ms.
- Autonomous mode <u>cannot</u> be set using the *Main measure area* function. To output a measure area autonomously, the function *Measure area* must be used.

5.1.1 Hot- / Coldspot function in autonomous operation

The setting for a hot- or coldspot in autonomous mode differs from the general procedure. Marking a measure area as hot- or coldspot does not work. Instead, a **user defined rectangle** must be selected under the tab **measure areas** of the configuration dialog. In addition, under **Mode**, you must set whether the **maximum** (for hotspot) or **minimum** (for coldspot) should be output.



Figure 38: Setting a hotspot for autonomous operation

For a hot- or coldspot output in the full field of view of the camera, the user defined rectangle must also fill out this size.

Note: Predefined Layout in the software available under Tools and Layouts: **Xi 80 Hot spot autonomous**

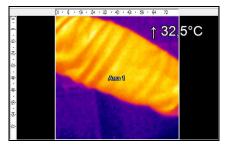


Figure 39: Measure area over entire field of view

5.2 Ethernet Xi 80

The Xi 80 has a direct Ethernet interface. The advantage is cable lengths of up to 100 m. For example, a switch can be used to extend the distances. The associated Ethernet cable (**Order No.: ACXIETCBx**) must be ordered separately. Ethernet is supported from software version Rel. 3.2.3020.0 and firmware 3008.

Using the Ethernet connection, the device must be supplied with power. This can be done either via:

- the internal PIF cable via the terminal block (5-30 V)
- the stackable PIF (5-24 V, Order No.: ACXIPIFCBx)
- PoE (Power over Ethernet)

i

For the PoE variant, a PoE adapter (**Order No.: ACXIETPOECB1**) and a PoE injector (**Order No.: ACPIPOE**) or PoE switch (e.g. Netgear GS510TLP) are also required.

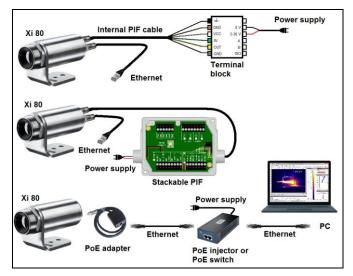


Figure 40: Possibilities of power supply for Xi 80 via Ethernet connection

Functions

5.2.1 Ethernet setup (Point-to-Point-Connection)

To make the appropriate address settings go to **Tools**, **Extended** and **TCP/IP Settings**. This setup is done via the camera's USB connection.

The address for the device is assigned under **Device address**. This must have a different address (last block) to the other participant (e.g., PC) (**Send to address**). It is important that the network part (first three blocks) must be identical for both addresses. The address range of the individual blocks can be between 0 and 255.

TCP/IP Settings	-		×
Device address (Xi80 #18044126):	192 . 16	B. O	. 101
Send to address (local device):	192 . 16	B. O	. 100
Subnet mask:	255 . 25	5.255	. 0
Port number:	50101		*
auto assign port number			
apply port number to this	instance		
ОК		Cance	I

Additionally, a separate **port number** must be configured. The selected number can be between 1 and 65535.

If the two options under port number are disabled, the Ethernet function must be activated. This is done under **Tools**, **Extended** and **Options**. The port number must be identical with the port number in TCP/IP Settings.

Ethernet devices			
Enable	Port:	50101	•



The port range used should be between **49152** ... **65535**. When using other ports, it could be that they are already reserved or assigned.

When a Windows Firewall window appears make sure to select allow all three networks parts (domain, private, public) in order to allow the communication with the device:

P Windows Security Alert	• 😭	Contro	ol Panel 🕨	System and Security Windows Firewall Allow	red Programs	•	∮ Search C
~	View	/ Tool	s Help				
Windows Firewall has blocked some features of this program			т	Ilow programs to communicate through o add, change, or remove allowed programs and por /hat are the risks of allowing a program to communi	s, click Change	settings.	ange settings
public, private and domain networks.			Γ	Allowed programs and features:			
Name: USB IR Camera Software (.NET 2.0, v90) Publisher: Unknown				Name	Domain	Home/Work (Private)	Public ^
Path: C:\program files (x86)\optris gmbh\pix connect\mager.exe				Remote Volume Management			
Allow USB IR Camera Software (.NET 2.0, v90) to communicate on these networks:				Secure Socket Tunneling Protocol SNMP Trap			
Domain networks, such as a workplace network				Teamviewer Remote Control Application	V		
Private networks, such as my home or work network				USB IR Camera Software (.NET 2.0, v90)	✓	✓	
				♥ vncviewer.exe ♥ vncviewer.exe			
Public networks, such as those in airports and coffee shops (not recommended because these networks often have little or no security)				W&T Netzwerkgeräte verwalten			
Milesters the side of ellevice a second describe formally				₩ W&T USB Redirector			v •
What are the risks of allowing a program through a firewall?						Details	Remove
G Allow access Cancel						Allow anothe	er program



The approval of programs can also be activated afterwards in the Windows Firewall settings of the PC (under *Windows Firewall* and *Allow a program or feature through Windows Firewall*).

Functions

Then you can close the software and disconnect the USB connection to the computer. Replace the USB cable with a purchased Ethernet cable.

Now you must set up the network address of the PC. To do this, go to **Control Panel** and open the **Network** and **Sharing Center**. Go on **LAN connection**.

View your basic network information and	d set up connections
your computer your current network	k Internet
View your active networks	Connect or disconnect
your current network Domain network	Access type: Local and Internet Connections: Uccal Area Connection

Optris

🔋 Local i	Area Connecti	on Status			X
General					
Conne	tion				
IPv	4 Connectivity:			Intern	et
IPv	5 Connectivity:		No ne	twork acce	SS
Med	ia State:			Enable	ed
Dur	ation:			00:05:	48
Spe	ed:			1.0 Gb	ps
	Details				
Activity					
		Sent —	-	Receive	ed
Byte	es:	96,057	1 T	29,9	98
P	operties	😗 Disable	Diagnose		
				Clo	ose

Click on Properties.

Mark Internet protocol Version 4 (TCP/IPv4) and go to Properties again

Local Area Connection Properties

This connection uses the following items: Client for Microsoft Networks QoS Packet Scheduler

Intel(R) PRO/1000 MT Network Connection

File and Printer Sharing for Microsoft Networks Internet Protocol Version 6 (TCP/IPv6)

ternet Protocol Version 4 (TCP/IPv4) Link-Layer Topology Discovery Mapper I/O Driver Link-Layer Topology Discovery Responder

Uninstall

Transmission Control Protocol/Internet Protocol. The default wide area network protocol that provides communication across diverse interconnected networks.

OK

Networking Connect using:

🖌 🎿

Install.

Description

X

Configure...

Properties

Cancel

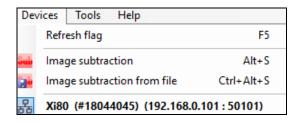
In the register card General enable the checkbox Use the following IP address. Now enter a user defined IP address for your PC (e.g. 192.168.0.100). This must be identical to the address set in the PIX Connect software.

this capability. Otherwise, you nee for the appropriate IP settings.	utomatically if your network suppor d to ask your network administrato
Obtain an IP address automa	tically
Our of the following IP address:	
IP address:	192.168.0.100
Subnet mask:	255.255.255.0
Default gateway:	
Obtain DNS server address a	utomatically
O Use the following DNS server	addresses:
Preferred DNS server:	
Alternate DNS server:	
Validate settings upon exit	Advanced.

Functions

Then close the windows with **OK** and you are finished with the Ethernet setup.

Start again the PIX Connect software. The existing Ethernet connection can be found in the menu under **Devices** and is identified by a network symbol and the network address of the device.



The device is now running via the Ethernet connection.

When using multiple Xi 80 cameras in a network, the data rate has to be considered:

- Í
- Switch with 100 Mbps: approx. 17 devices
- Switch with 1000 Mbps: approx. 170 devices

In addition to the data rate also make sure the power performance of the PC is high enough. Each device used requires its own instance.

5.3 Use of Shutter

The shutter system is supplied with a control box (for pin assignment, see also **Figure 15**). The servo motor of the shutter is connected to this control box. There are several ways to operate the control box. For all listed options, an input signal (IN 1) must be connected. This input signal can, for example, come from a PLC, a light barrier or a sensor. This signal opens and closes the shutter. A second input signal (IN 3) can be used to realize a fast-closing mode. The closing time in this mode is only 100 ms.

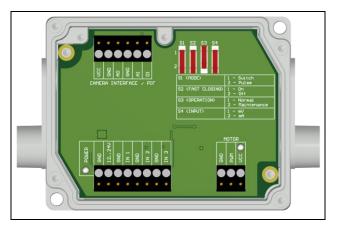


Figure 41: Control box Shutter

By using the process interface (PIF), the input signal to the software can be passed on and used as a trigger signal in the software. For example, an automatic recording can take place when the shutter is opened.

The process interface cable supplied with the cameras can be connected directly to the control box (upper terminal block: CAMERA INTERFACE / PIF). Alternatively, the separately obtained industrial or stackable PIF can also be connected to the control box (if several outputs and inputs are used). In this case, the outputs and inputs used (e.g. AO from control box with AO from PIF) must be connected with each other.

Figure 41).

When using more than one shutter and the opening / closing of the shutter should be simultaneously, the switch S4 on one control box must be set to mA and the others to mV (see

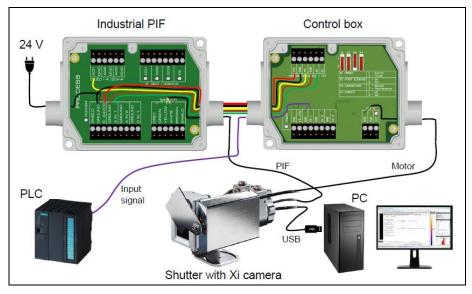


Figure 42: Connection of control box, shutter and industrial PIF

5.3.1 Settings in PIX Connect Software

After the hardware installation (connection control box shutter and PIF) the following settings can be made in the software:

• Automatic Recording: By opening the shutter through input signal IN 1, an automatic recording can be started. For this, the AI must be configured to *Triggered Recording* in the software in the configuration menu *Device (PIF)*.

Analog Inputs (1) + -		
AI: Triggered Recording	👻 🖌 Setup	Threshold: 2V (high active)

• **Close shutter after recording/line scan**: When the recording is finished, the shutter can be closed by an analog signal. To do this, in the software in the configuration menu *Device (PIF)* of the AO must be configured for *Recording Status*. If the shutter is to be closed after a line scan, *Line scan status* must be selected.



6 IRmobile App

The imagers have a direct connection to an Android smartphone or tablet. All you must do is download the IRmobile app for free in the Google Play Store. This can also be done via the QR code. An IRmobile app connector is recommended for connection to the device (Xi 80: Part-No.: ACXI80IACM (micro USB) or ACXI80IACC (USB-C), Xi 400: Part-No.: ACPIIACM (micro USB) or ACPIIACC (USB-C).





With IRmobile you can monitor and analyze your infrared temperature measurement directly on a connected smartphone or tablet. All you need is an Optris infrared camera. This app runs on most Android (5 or higher) devices with a micro USB port or USB-C port that supports USB OTG (On The Go). The app is easy to use:

+optris

After you have connected your camera to the micro USB port or USB-C port of your smartphone or tablet, the app launches automatically. The calibration files are automatically downloaded from the internet. The device is powered by your smartphone. A hotspot indicates the hottest pixel in the image and a coldspot the coldest pixel in the image.

IRmobile app features:

- Live infrared image with automatic hot-/ and coldspot search
- > Changing the color palette, scaling and temperature range
- > Change of temperature unit: Celsius or Fahrenheit
- Setting of temperature range scaling (Manual, Min/Max, 3 sigma)
- Creating a snapshot
- Integrated simulator

IRmobile supported for:

- > Optris IR cameras: Xi and PI series
- Optris pyrometers: Compact series, high performance series and video thermometers
- For Android 5 (or higher) devices with a micro USB port or USB C port that supports USB OTG (On The Go)



82

7 Software PIX Connect

Minimum system requirements:

- Windows 7, Windows 8, Windows 10
- USB interface
- Hard disc with at least 30 MByte of free space
- At least 128 MByte RAM



A detailed description is provided in the software manual on the USB stick. See also Help menu in the PIX Connect software ($\texttt{Help} \rightarrow \texttt{Documentation}$).



Alternatively, the software can also be downloaded via the Optris website under the following link: <u>https://www.optris.global/pix</u>

7.1 Installation and initial start-up

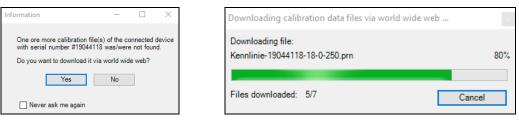
- All drivers are booted via Windows OS automatically. A driver installation is not necessary.
 - By default, the program starts automatically in the installed language.
- 1. Insert the included USB stick into the according port on your computer.
- 2. Please start **Setup.exe**. Follow the instructions of the wizard until the installation is finished.

The installation wizard places a launch icon on the desktop and in the start menu: Start\Programs\Optris GmbH\PIX Connect

- 3. To connect the camera to the PC, plug the USB cable to the camera first. Afterwards connect it with the PC (to disconnect the camera and the computer remove the USB cable from the computer first and then disconnect it from the camera).
- 4. Start the software.

At the initial start the software asks for the calibrations files which are available via internet or on the USB stick (only for Xi 400). With the Xi 80, the calibration files are already included in the device.

5. Install the calibration files at first start of the software (only necessary for Xi 400).



After the calibration files have been installed the live image from the camera is shown inside a window on your PC screen.

- 6. Choose the desired language in the menu **Tools** \rightarrow **Language**.
- 7. Adjust the focus of the image by using the distance function in the software (Menu View/ Windows/ Distance or over the icon iii):



7.2 Software window

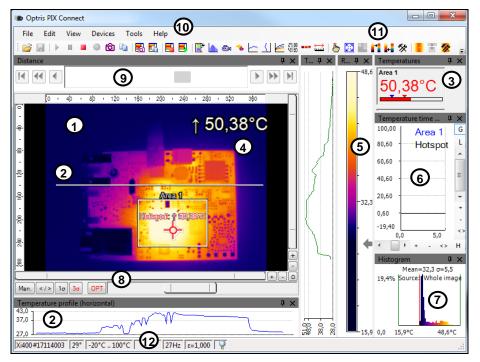


Figure 43: Software window

Software PIX Connect

- 1 IR image from the camera
- 2 Temperature profile: Shows the temperatures along max. 2 lines at any size and position in the image.
- 3 Control displays: Displays all temperature values in the defined measure areas like Cold Spots, Hot Spots, temperature at cursor, internal temperature and chip temperature.

Alarm settings: Bar showing the defined temperature thresholds for low alarm value (blue arrow) and high alarm value (red arrow). The color of numbers within control displays changes to red (when temp. above the high alarm value) and to blue (when temp. below the low alarm value).

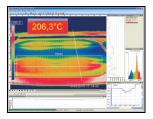
- 4 Temperature of measure area: Analyses the temperature according to the selected shape, e.g. average temperature of the rectangle. The value is shown inside the IR image and the control displays.
- 5 Reference bar: Shows the scaling of temperature within the color palette.
- 6 Temperature time diagram: Shows the temperature curves over time for selectable region of interest (ROI)
- 7 Histogram: Shows the statistic distribution of single temperature values.
- 8 Automatic / manual scaling of the palette (displayed temperature range): Man., </> (min, max), 1σ : 1 Sigma, 3σ : 3 Sigma, OPT: Palette optimization
- 9 Distance function: Adjustment of the motor focus to focus the IR picture
- 10 Menu and Toolbar (Icons)
- 11 Icon enabling switching between color palettes
- 12 Status bar: Serial number, optic, temperature range, cursor position, device framerate/ display framerate, emissivity, ambient temperature, flag status

7.3 Basis features of the software PIX Connect

Windows[®]

Extensive infrared camera software

- No restrictions in licensing
- Modern software with intuitive user interface
- Remote control of camera via software
- Display of multiple camera images in different windows
- Compatible with Windows 7, 8 and 10



High level of individualization for customer specific display

- Various language option including a translation tool
- Temperature display in °C or °F
- Different layout options for an individual setup (arrangement of windows, toolbar)
- Range of individual measurement parameter fitting for each application
- Adaption of thermal image (mirror, rotate)
- Individual start options (full screen, hidden, etc.)

88

Software PIX Connect

· Carlo NY Connect No. 11				ALC: NO.
	DU BE BB P	a shuld	0	
No. (e)	0	(6) (6)	N DISK NUMBER	65.6°C
		0	ξ.	Accel 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
			10 10 10 10 10 10 10 10 10 10 10 10 10 1	Figure 2 and 2 and 2

Video recording and snapshot function (IR)

- Recording of video sequences and detailed frames for further analysis or documentation
- Adjustment of recording frequency to reduce data volume
- Display of snapshot history for immediate analysis

207.5	Area 1	and a		- here	~		G
	Area 2		n	_			-
34,1	Area 3						
					1		*
4,1		A			-	ŝ	

Extensive online and offline data analysis

- Analysis supported by measurement fields, hot and cold spot searching, image subtraction
- Real time temperature information within main window as digital or graphic display (line profile, temperature time diagram)
- Slow motion repeat of radiometric files and analysis without camera being connected
- Editing of sequences such as cutting and saving of individual images
- Various color palettes to highlight thermal contrasts



Automatic process control

- Individual setup of alarm levels depending on the process
- Definition of visual or acoustic alarms and analog data output
- Analog and digital signal input (process parameter)
- External communication of software via COM-Ports and DLL
- Adjustment of thermal image via reference values

Temperature data analysis and documentation

- Triggered data collection
 Radiometric video sequences (*.ravi) radiometric snapshots (*.tiff)
 - Text files including temp. information for analysis in Excel (*.csv, *.dat)
 - Data with color information for standard programs such as Photoshop or Windows Media Player (*.avi, *.tiff)
 - Data transfer in real time to other software programs DLL or COM-Port interfaces

V		81								
	1187	1125	112.4	1924	017	112.6	100	193	1944	100
	1114	112.6	110.0	111	110.4	112.5	115.0	104	118.1	112.5
	118.9	118.0	115.6	10.1	178.8	118.5	198.6	1944	187	118.8
	120	118.0	128.1	- 124	118.4	178.5	118.6	1244	1244	128.4
	122.8	122	122.5	123.2	123.7	123.9	124.2	125.2	125.4	582
	132.8	152.5	140.5	141.2	101.7	144.0	145.6	147.7	145.4	
	120.5 M8.7	147.2	HTP	186.7	101.0	177.4	172.2	175.4	194.8	- 199.2
	107.7	188.2	189.1	100.7	1012	102.5	185	104.4	10.1	106.0
	206.0	208.1	207.3	- 200	228.4	212.8	272.2	2183	214.5	2114
	222.2	222.5	224.4	225.4	228.9	222.4	229.7	236.7	214.5	201.2
				225.8						
	156.8	237.0	255.4		240.5	241.4	247.0	240.1	241.8	244.4
	244.5	244.6	244.6	245.4	248.8	245	245.4	248.7	247	247.2
	248.4	244.6	246.7	246.8	247.2	247.8	247.6	248.2	248	248.2
	247.2	247.2	247.6	3472	328.4	348.1	248.4	229.2	344.8	34k ?
	248.8	248.9	248.5	216.4	218-4	248.5	248.4	249.2	208-8	248.9
	251.3	224.4	251.6	351.4	253.2	248.0	280.7	246.1	248.4	347.A
	253.8	251.4	255.6	252.8	251.5	248.4	251.5	246.2	247	241.2
	255	251.6	252	251.5	252.9	243.4	248.9	240.1	248	245.5
	255.7	292.5	232.7	252.3	2917	295.2			229.4	
		222								
22			209.2	229.7	208-4	258.2	287.2	206.3	257.2	206.7
	301.4	200.6	199.3		205	202.6	200	198.5	126.8	200.9
	197.5	201.4	205.5	204.8	202.2	203.2	296.5	208.1	208.2	204.7
	202.5	7.575	205.6	298.3	208.2	304.7	209.5	202.1	214.1	212.9
	208.0	204.7	209.1	271.3	213.4	212.5	312	284	218.1	- 201
	213									
	218.9	213.0	217.5	293	223.4	227.1	228.4	225.6	221.2	226.8

8 Basics of Infrared Thermometry

Depending on the temperature each object emits a certain amount of infrared radiation. A change in the temperature of the object is accompanied by a change in the intensity of the radiation.

Searching for new optical material William Herschel by chance found the infrared radiation in 1800.

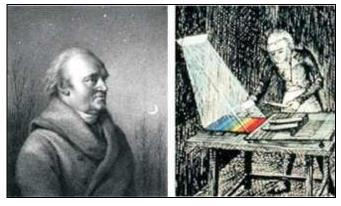


Figure 44: William Herschel (1738-1822)

He blackened the peak of a sensitive mercury thermometer. This thermometer, a glass prism that led sun rays onto a table made his measuring arrangement. With this, he tested the heating of different colors of the spectrum. Slowly moving the peak of the blackened thermometer through the colors of the spectrum, he

noticed the increasing temperature from violet to red. The temperature rose even more in the area behind the red end of the spectrum. Finally he found the maximum temperature far behind the red area.

Nowadays this area is called "infrared wavelength area".

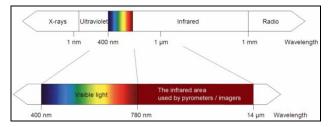


Figure 45: The electromagnetic spectrum and the area used for temperature measurement

For the measurement of "thermal radiation" infrared thermometry uses a wave-length ranging between 1 μ m and 20 μ m. The intensity of the emitted radiation depends on the material. This material contingent constant is described with the help of the emissivity which is a known value for most materials (**>9 Emissivity**).

Infrared thermometers are optoelectronic sensors. They calculate the surface temperature based on the emitted infrared radiation from an object. The most important feature of infrared thermometers is that they enable the user to measure objects contactless. Consequently, these products help to measure the temperature of inaccessible or moving objects without difficulties.

Basics of Infrared Thermometry

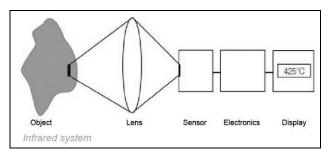


Figure 46: Main principle of non-contact thermometry

Infrared thermometers basically consist of the following components:

- Lens
- Spectral filter
- Detector
- Electronics (amplifier/ linearization/ signal processing)

The specifications of the lens decisively determine the optical path of the infrared thermometer, which is characterized by the ratio Distance to Spot size. The spectral filter selects the wavelength range, which is relevant for the temperature measurement. The detector in cooperation with the processing electronics transforms the emitted infrared radiation into electrical signals.

The advantages of non-contact thermometry are clear - it supports:

- temperature measurements of moving or overheated objects and of objects in hazardous surroundings
- very fast response and exposure times
- measurement without inter-reaction, no influence on the
- measuring object
- non-destructive measurement
- long lasting measurement, no mechanical wear

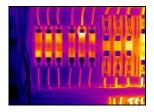


Figure 47: Non-contact thermometry

94

Basics of Infrared Thermometry

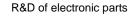
Application field:





Monitoring of electronic cabinets

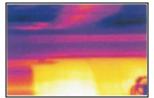
R&D of electronics



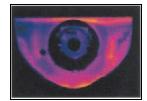
Process control extruding

1200	

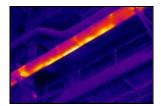
Process control manufacturing solar modules



Process control at calendering



R&D of mechanical parts



Monitoring of cables

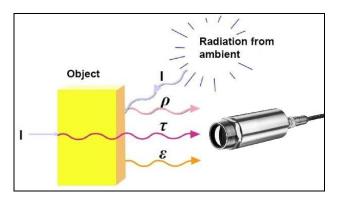
plastic parts

95

9 Emissivity

9.1 Definition

The intensity of infrared radiation, which is emitted by each body, depends on the temperature as well as on the radiation features of the surface material of the measuring object. The emissivity (ϵ – Epsilon) is used as a material constant factor to describe the ability of the body to emit infrared energy. It can range between 0 and 100 %. A "blackbody" is the ideal radiation source with an emissivity of 1.0 whereas a mirror shows an emissivity of 0.1.



IR radiation

- ε Emission
- p Reflection
- Transmission

Figure 48: Composition of IR radiation

Emissivity

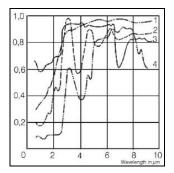


Figure 49: Spectral emissivity of several materials: 1 Enamel, 2 Plaster, 3 Concrete, 4 Chamotte

If the emissivity chosen is too high, the infrared thermometer may display a temperature value which is much lower than the real temperature – assuming the measuring object is warmer than its surroundings. A low emissivity (reflective surfaces) carries the risk of inaccurate measuring results by interfering infrared radiation emitted by background objects (flames, heating systems, chamottes). To minimize measuring errors in such cases, the handling should be performed very carefully, and the unit should be protected against reflecting radiation sources.

97

9.2 Determination of unknown emissivity

- ► First determine the actual temperature of the measuring object with a thermocouple or contact sensor. Second, measure the temperature with the infrared thermometer and modify the emissivity until the displayed result corresponds to the actual temperature.
- If you monitor temperatures of up to 380 °C you may place a special plastic sticker (emissivity dots Part No.: ACLSED) onto the measuring object, which covers it completely.

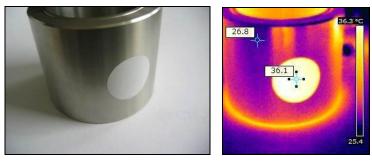


Figure 50: Plastic sticker at metal surface

Set the emissivity to 0.95 and take the temperature of the sticker. Afterwards, determine the temperature of the adjacent area on the measuring object and adjust the emissivity according to the value of the temperature of the sticker.

Emissivity

Cove a part of the surface of the measuring object with a black, flat paint with an emissivity of 0.98. Adjust the emissivity of your infrared thermometer to 0.98 and take the temperature of the colored surface. Afterwards, determine the temperature of a directly adjacent area and modify the emissivity until the measured value corresponds to the temperature of the colored surface.





Figure 51: Shiny metal surface left and blackened metal surface right

CAUTION: On all three methods the object temperature must be different from ambient temperature.

9.3 Characteristic emissivity

In case none of the methods mentioned above help to determine the emissivity you may use the emissivity table ► Appendix A and Appendix B. These are average values, only. The actual emissivity of a material depends on the following factors:

- temperature
- measuring angle
- geometry of the surface
- thickness of the material
- constitution of the surface (polished, oxidized, rough, sandblast)
- spectral range of the measurement
- transmissivity (e.g. with thin films)

Fixed radiometric values		
Emissivity:	1,000	* *
Transmissivity: (IR-window compensation)	1,000	▲ ▼
Ambient temperature:	23,0	[°C]

Figure 52: Adjustment of the emissivity in the software PIX Connect (menu Tools/ Configuration/ Device)

100

Appendix A – Table of emissivity for metals

	Material	typical Emissivity						
Spec	tral response	1.0 µm	1.6 µm	5.1 µm	8-14 μm 0.02-0.1			
Aluminium	non oxidized	0.1-0.2	0.02-0.2	0.02-0.2				
	polished	0.1-0.2	0.02-0.1	0.02-0.1	0.02-0.1			
	roughened	0.2-0.8	0.2-0.6	0.1-0.4	0.1-0.3			
	oxidized	0.4	0.4	0.2-0.4	0.2-0.4			
Brass	polished	0.35	0.01-0.05	0.01-0.05	0.01-0.05			
	roughened	0.65	0.4	0.3	0.3			
	oxidized	0.6	0.6	0.5	0.5			
Copper	polished	0.05	0.03	0.03	0.03			
	roughened	0.05-0.2	0.05-0.2	0.05-0.15	0.05-0.1			
	oxidized	0.2-0.8	0.2-0.9	0.5-0.8	0.4-0.8			
Chrome		0.4	0.4	0.03-0.3	0.02-0.2			
Gold		0.3	0.01-0.1	0.01-0.1	0.01-0.1			
Haynes	alloy	0.5-0.9	0.6-0.9	0.3-0.8	0.3-0.8			
Inconel	electro polished	0.2-0.5	0.25	0.15	0.15			
	sandblast	0.3-0.4	0.3-0.6	0.3-0.6	0.3-0.6			
	oxidized	0.4-0.9	0.6-0.9	0.6-0.9	0.7-0.95			
Iron	non oxidized	0.35	0.1-0.3	0.05-0.25	0.05-0.2			
	rusted		0.6-0.9	0.5-0.8	0.5-0.7			
	oxidized	0.7-0.9	0.5-0.9	0.6-0.9	0.5-0.9			
	forged, blunt	0.9	0.9	0.9	0.9			
	molten	0.35	0.4-0.6	000000	Southers.			
Iron, casted	non oxidized	0.35	0.3	0.25	0.2			
ALL STREET, STREET, ST	oxidized	0.9	0.7-0.9	0.65-0.95	0.6-0.95			

	Material	typical Emissivity							
Spect	tral response	1.0 µm	1.6 µm	5.1 µm	8-14 μm 0.05-0.1 0.4				
Lead	polished roughened	0.35 0.65	0.05-0.2	0.05-0.2					
	oxidized	c c	0.3-0.7	0.2-0.7	0.2-0.6				
Magnesium		0.3-0.8	0.05-0.3	0.03-0.15	0.02-0.1				
Mercury			0.05-0.15	0.05-0.15	0.05-0.15				
Molybdenum	non oxidized	0.25-0.35	0.1-0.3	0.1-0.15	0.1				
	oxidized	0.5-0.9	0.4-0.9	0.3-0.7	0.2-0.6				
Monel (Ni-Cu)		0.3	0.2-0.6	0.1-0.5	0.1-0.14				
Nickel	electrolytic	0.2-0.4	0.1-0.3	0.1-0.15	0.05-0.15				
	oxidized	0.8-0.9	0.4-0.7	0.3-0.6	0.2-0.5				
Platinum	black	8	0.95	0.9	0.9				
Silver		0.04	0.02	0.02	0.02				
Steel	polished plate	0.35	0.25	0.1	0.1				
	rustless	0.35	0.2-0.9	0.15-0.8	0.1-0.8				
	heavy plate	1 82884-04 2010 - 2010 - 2010		0.5-0.7	0.4-0.6				
	cold-rolled	0.8-0.9	0.8-0.9	0.8-0.9	0.7-0.9				
	oxidized	0.8-0.9	0.8-0.9	0.7-0.9	0.7-0.9				
Tin non oxidized		0.25	0.1-0.3	0.05	0.05				
Titanium	polished	0.5-0.75	0.3-0.5	0.1-0.3	0.05-0.2				
	oxidized		0.6-0.8	0.5-0.7	0.5-0.6				
Wolfram	polished	0.35-0.4	0.1-0.3	0.05-0.25	0.03-0.1				
Zinc	polished	0.5	0.05	0.03	0.02				
191919-112	oxidized	0.6	0.15	0.1	0.1				

Appendix B – Table of emissivity for non-metals

Material		typical Emissivity							
Spectr	al response	1.0 µm	2.2 µm	5.1 µm	8-14 μm 0.95 0.95				
Asbestos	all contract of the second	0.9	0.8	0.9					
Asphalt				0.95					
Basalt		3		0.7	0.7				
Carbon	non oxidized		0.8-0.9	0.8-0.9	0.8-0.9				
8	graphite		0.8-0.9	0.7-0.9	0.7-0.8				
Carborundum			0.95	0.9	0.9				
Ceramic		0.4	0.8-0.95	0.8-0.95	0.95				
Concrete		0.65	0.9	0.9	0.95				
Glass	plate melt		0.2 0.4-0.9	0.98 0.9	0.85				
Grit				0.95	0.95				
Gypsum		5		0.4-0.97	0.8-0.95				
lce				· · ·	0.98				
Limestone				0.4-0.98	0.98				
Paint	non alkaline				0.9-0.95				
Paper	any color			0.95	0.95				
Plastic >50 µm	non transparent			0.95	0.95				
Rubber	116.0110.0	2	-	0.9	0.95				
Sand		3		0.9	0.9				
Snow		5 8	-	5 5	0.9				
Soil		2		(4	0.9-0.98				
Textiles				0.95	0.95				
Water					0.93				
Wood	natural			0.9-0.95	0.9-0.95				

Appendix C – Quick start for serial communication

Introduction

One special feature of the PIX Connect software contains the possibility to communicate via a serial COM-Port interface. This can be a physical COM-Port or a virtual COM-Port (VCP). It must be available on the computer where the PIX connect software is installed.

Setup of the interface

1. Open the **Options** dialog and enter the tab "**Extended Communication**" to enable the software for the serial communication.

	Configuration												
	General	Measure a	areas T	emp. profiles	Temp/Time	diagram	Device	Dev	ice (PIF)	Referencing	Recording	Playing	
	Snapshot	s / Copy to	clipboar	d Trig. Reco	rdi <u>ng / Snap</u>	shots Ca	apture S	creen	Histogran	n Extended r	neasuring	Measuring	colors
	IR Image	arranging	Alarms	Event grabb	er External	Communic	cation	Extend	ed Layout				
ľ													

2. Select the mode "COM-Port" and choose the appropriate port.

Mode					
Off 🔘	0	onnect SDK (IPC	C) COM-Port 		
COM-Port					
Port:	Kommunikationsanschluss (COM1)				
Baud rate:		9600	•		
Bus address	:	1			

3. Select the baud rate that matches the baud rate of the other communication device. The other interface parameters are 8 data bits, no parity and one stop bit (8N1).

These parameters are used in many other communication devices too. The other station must support 8 bit data.

4. Connect the computer with the communication device. If this is a computer too, use a null modem cable.

Command list



The command list is provided on the USB stick and in the PIX Connect software (Help \rightarrow SDK). Every command must expire with CR/LF (0x0D, 0x0A).

Appendix D – Interprocess Communication (IPC)

The description of the initialization procedure as well as the necessary command list is provided on the USB stick and in the PIX Connect software ($\texttt{Help} \rightarrow \texttt{SDK}$).

2 SDK packages are available (included on USB stick):

- 1. Connect SDK: requires the PIX Connect software
- 2. Direct SDK: no PIX Connect software required, supports Linux and Windows

The communication to the process imager device is handled by the PIX Connect software (Imager.exe) only. A dynamic link library (ImagerIPC2.dll) provides the interprocess communication (IPC) for other attached processes. The DLL can be dynamically linked into the secondary application. Or it can be done static by a lib file too. Both Imager.exe and ImagerIPC2.dll are designed for Windows 7/ 8/ 10 only. The application must support call-back functions and polling mode.

The ImagerIPC2.dll will export a bunch of functions that are responsible for initiating the communication, retrieving data and setting some control parameters.

The main difference to the former Version 1 (ImagerIPC.dll) is the support of more than one Optris Xi via multiple instances of Optris PIX Connect.

Appendix E – PIX Connect Resource Translator



A detailed tutorial is provided on the USB stick.

PIX Connect is a .Net Application. Therefore, it is ready for localization. Localization as a Microsoft idiom means a complete adaption of resources to a given culture. Learn more about the internationalization topics consult Microsoft's developer documentation on

http://msdn.microsoft.com/en-us/goglobal/bb688096.aspx.

If desired the localization process can be illustrated in detail. Also, the resizing of buttons or other visible resources and the support of right-to-left-languages are supported. Experts who have the appropriate tools should handle it. Nevertheless, we have developed the small tool "Resource Translator" to make the translation of the resources of the PIX Connect application possible for everybody.

This tool helps to translate any visible text within the PIX Connect application.

Appendix F – Wiring diagrams PIF for Xi 400

Analog Output:

The maximum load impedance is 500 Ohm.

The analog output can be used as a digital output too. The current value for "no alarm" and "alarm on" is set within the software.

Appendix F – Wiring diagrams PIF for Xi 400

Digital Input:

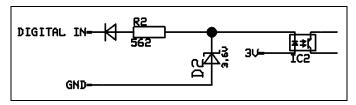


Figure 53: Digital input

The digital input can be activated with a button to the Xi GND-Pin or with a low level CMOS/TTL signal: Low level 0...0.6 V; High level 2...24 V

Example Button:

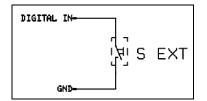


Figure 54: Button

109

Analog input (usable voltage range: 0 ... 10 V):

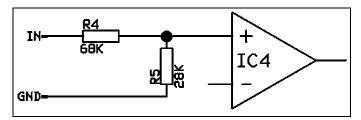


Figure 55: Analog input

Relay output at industrial PIF [Part No.: ACPIPIFMACBxx]

The analog output must be set to "Alarm". The range for AO1-AO3 can be set in the software (no alarm: 0-4 mA/ alarm: 10-20 mA).

REL1-3 (DO1-DO3): U_{max} = 30 VDC

 $I_{max} = 400 \text{ mA}$

Appendix F – Wiring diagrams PIF for Xi 400

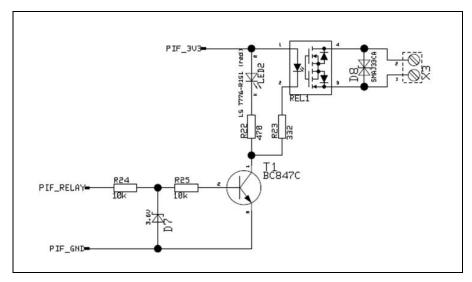
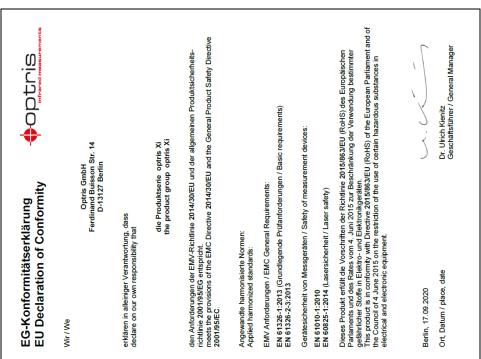


Figure 56: Relay output at industrial PIF

111



Appendix G – Declaration of Conformity

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